What is claimed is:

1. A foldable electronic device comprising a main body (1) and a closure (2) connected to each other openably, a main display (4) having a screen exposed from an inner surface of the closure (2), a subdisplay (5) having a screen exposed from a back surface of the closure (2), a frame (6) being provided inside the closure (2) and holding therein the main display (4) and the subdisplay (5) as arranged back to back, a chip mount area (42) of a flexible lead (41) extending from the main display (4) and a chip mount area (53) of a flexible lead (51) extending from the subdisplay (5) being opposed to each other in an opening formed in the frame (6), opposed surfaces of the respective chip mount areas (42)(53) having groups of electronic circuit chips (43)(54) mounted thereon as positioned in a staggered relation with each other.

2. A foldable electronic device according to claim 1 wherein the flexible lead (51) extending from the subdisplay (5) has an outer end portion folded over toward the frame (6) side, and the folded-over portion has a surface opposed to the frame (6) and providing the chip mount area (53).

3. A foldable electronic device according to claim 2 wherein the frame (6) has said opening in a second area thereof adjacent to a first area thereof covered with the

subdisplay (5), and the flexible lead (51) extending from the subdisplay (5) is folded over on the second area, the electronic circuit chips (54) in the chip mount area (53) being positioned in said opening of the frame (6).

4. A foldable electronic device according to claim 3 wherein the flexible lead (41) extending from the main display (4) is folded over toward the frame (6) side, and the folded-over lead portion has a surface opposed to the frame (6) and providing the chip mount area (42), the electronic circuit chips (43) in the chip mount area (42) being positioned in said opening of the frame (6).